

Product Specification

XBLW SN74HC238

3-to-8 Line Decoder/Demultiplexer

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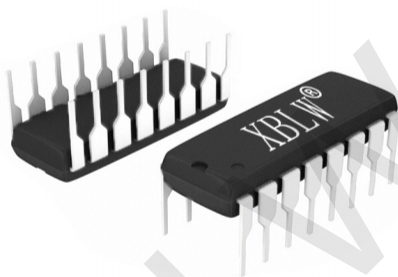


Description

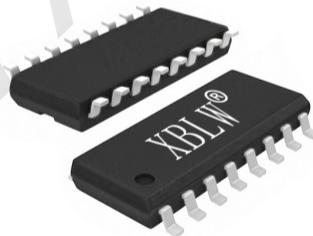
The SN74HC238 decodes three binary weighted address inputs (A0, A1 and A2) to eight mutually exclusive outputs (Y0 to Y7). The device features three enable inputs (E1 and E2 and E3). Every output will be LOW unless E1 and E2 are LOW and E3 is HIGH. This multiple enable function allows easy parallel expansion to a 1-of-32 (5 to 32 lines) decoder with just four SN74HC238 ICs and one inverter. The SN74HC238 can be used as an eight output demultiplexer by using one of the active LOW enable inputs as the data input and the remaining enable inputs as strobes. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

Features

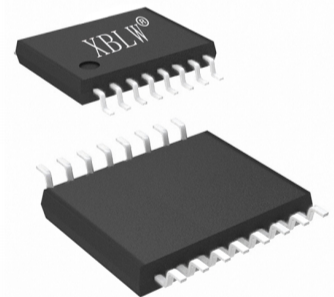
- Demultiplexing capability
- Multiple input enable for easy expansion
- Ideal for memory chip select decoding
- Active HIGH mutually exclusive outputs
- Specified from -40°C to +125°C
- Packaging information: DIP-16/SOP-16/TSSOP-16



DIP-16



SOP-16



TSSOP-16

Ordering Information

Product Model	Package Type	Marking	Packing	Packing Qty
XBLW SN74HC238N	DIP-16	74HC238N	Tube	1000Pcs/Box
XBLW SN74HC238DTR	SOP-16	74HC238	Tape	2500Pcs/Reel
XBLW SN74HC238TDTR	TSSOP-16	74HC238	Tape	3000Pcs/Reel

Block Diagram

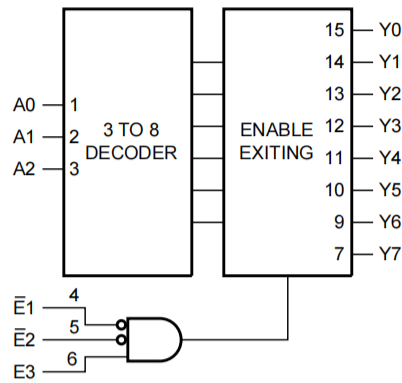


Figure 1. Logic symbol

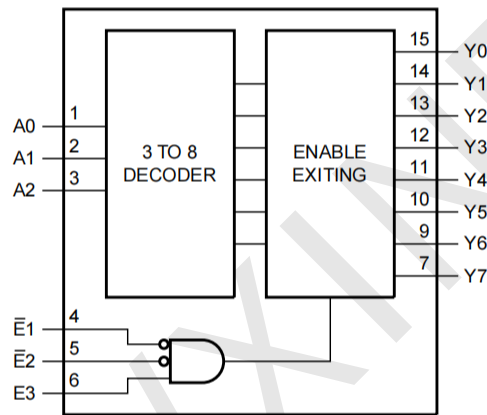


Figure 2. Functional diagram

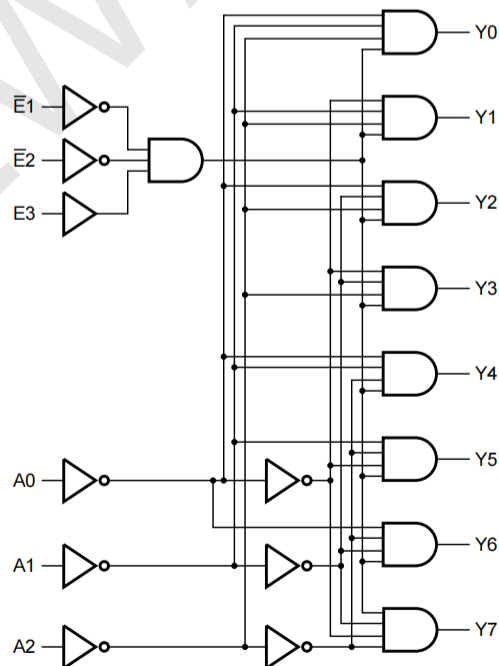
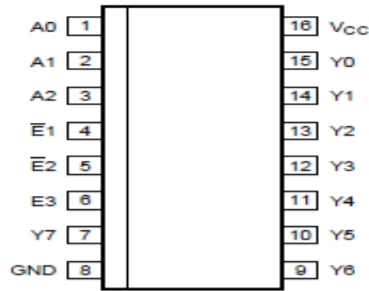


Figure 3. Logic diagram

Pin Configurations



Pin Description

Pin No.	Pin Name	Description
1	A0	address input
2	A1	address input
3	A2	address input
4	$\bar{E}1$	enable input (active LOW)
5	$\bar{E}2$	enable input (active LOW)
6	E3	enable input (active HIGH)
7	Y7	output (active HIGH)
8	GND	ground (0V)
9	Y6	output (active HIGH)
10	Y5	output (active HIGH)
11	Y4	output (active HIGH)
12	Y3	output (active HIGH)
13	Y2	output (active HIGH)
14	Y1	output (active HIGH)
15	Y0	output (active HIGH)
16	V _{cc}	supply voltage

Function Table

Input						Output							
$\bar{E}1$	$\bar{E}2$	E3	A0	A1	A2	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
H	X	X	X	X	X	L	L	L	L	L	L	L	L
X	H	X	X	X	X	L	L	L	L	L	L	L	L
X	X	L	X	X	X	L	L	L	L	L	L	L	L
L	L	H	L	L	L	H	L	L	L	L	L	L	L
L	L	H	H	L	L	L	H	L	L	L	L	L	L
L	L	H	L	H	L	L	L	H	L	L	L	L	L
L	L	H	H	H	L	L	L	L	H	L	L	L	L
L	L	H	L	L	H	L	L	L	L	H	L	L	L
L	L	H	H	L	H	L	L	L	L	L	H	L	L
L	L	H	L	H	H	L	L	L	L	L	L	H	L
L	L	H	H	H	H	L	L	L	L	L	L	L	H

Note: H=HIGH voltage level; L=LOW voltage level; X=don't care.

Electrical Parameter

Absolute Maximum Ratings

(Voltages are referenced to GND(ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{CC}	-	-0.5	+7.0	V
input clamping current	I_{IK}	$V_I < -0.5V$ or $V_I > V_{CC}+0.5V$	-	± 20	mA
output clamping current	I_{OK}	$V_O < -0.5V$ or $V_O > V_{CC}+0.5V$	-	± 20	mA
output current	I_O	$-0.5V < V_O < V_{CC}+0.5V$	-	± 25	mA
supply current	I_{CC}	-	-	+50	mA
ground current	I_{GND}	-	-50	-	mA
storage temperature	T_{stg}	-	-65	+150	°C
total power dissipation	P_{tot}	-	-	500	mW
Soldering temperature	T_L	10s	DIP	245	°C
			SOP	250	°C

Note:

[1] For DIP16 packages: above 70°C the value of P_{tot} derates linearly with 12mW/K.

[2] For SOP16 packages: above 70°C the value of P_{tot} derates linearly with 8mW/K.

[3] For (T)SSOP16 packages: above 60°C the value of P_{tot} derates linearly with 5.5mW/K.

Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{CC}	-	2.0	5.0	6.0	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	$\Delta t/\Delta V$	$V_{CC}=2.0V$	-	-	625	ns/V
		$V_{CC}=4.5V$	-	1.67	139	ns/V
		$V_{CC}=6.0V$	-	-	83	ns/V
ambient temperature	T_{amb}	-	-40	-	+105	°C

Electrical Characteristics

DC Characteristics 1

($T_{amb}=25^{\circ}C$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC238							
HIGH-level input voltage	V _{IH}	V _{CC} =2.0V		1.5	1.2	-	V
		V _{CC} =4.5V		3.15	2.4	-	V
		V _{CC} =6.0V		4.2	3.2	-	V
LOW-level input voltage	V _{IL}	V _{CC} =2.0V		-	0.8	0.5	V
		V _{CC} =4.5V		-	2.1	1.35	V
		V _{CC} =6.0V		-	2.8	1.8	V
HIGH-level output voltage	V _{OH}	V _I = V _{IH} or V _{IL}	I _O =-20uA; V _{CC} =2.0V	1.9	2.0	-	V
			I _O =-20uA; V _{CC} =4.5V	4.4	4.5	-	V
			I _O =-20uA; V _{CC} =6.0V	5.9	6.0	-	V
			I _O =-4.0mA; V _{CC} =4.5V	3.98	4.32	-	V
			I _O =-5.2mA; V _{CC} =6.0V	5.48	5.81	-	V
LOW-level output voltage	V _{OL}	V _I = V _{IH} or V _{IL}	I _O =20uA; V _{CC} =2.0V	-	0	0.1	V
			I _O =20uA; V _{CC} =4.5V	-	0	0.1	V
			I _O =20uA; V _{CC} =6.0V	-	0	0.1	V
			I _O =4.0mA; V _{CC} =4.5V	-	0.15	0.26	V
			I _O =5.2mA; V _{CC} =6.0V	-	0.16	0.26	V
input leakage current	I _I	V _I =V _{CC} or GND; V _{CC} =6.0V		-	-	±1	uA
supply current	I _{CC}	V _I =V _{CC} or GND; I _O =0A; V _{CC} =6.0V		-	-	8.0	uA
Input capacitance	C _I	-		-	3.5	-	pF

DC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	$V_{CC}=2.0V$		1.5	-	-	V
		$V_{CC}=4.5V$		3.15	-	-	V
		$V_{CC}=6.0V$		4.2	-	-	V
LOW-level input voltage	V_{IL}	$V_{CC}=2.0V$		-	-	0.5	V
		$V_{CC}=4.5V$		-	-	1.35	V
		$V_{CC}=6.0V$		-	-	1.8	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH} \text{ or } V_{IL}$	$I_O=-20\mu A; V_{CC}=2.0V$	1.9	-	-	V
			$I_O=-20\mu A; V_{CC}=4.5V$	4.4	-	-	V
			$I_O=-20\mu A; V_{CC}=6.0V$	5.9	-	-	V
			$I_O=-4.0mA; V_{CC}=4.5V$	3.84	-	-	V
			$I_O=-5.2mA; V_{CC}=6.0V$	5.34	-	-	V
LOW-level output voltage	V_{OL}	$V_I = V_{IH} \text{ or } V_{IL}$	$I_O=20\mu A; V_{CC}=2.0V$	-	-	0.1	V
			$I_O=20\mu A; V_{CC}=4.5V$	-	-	0.1	V
			$I_O=20\mu A; V_{CC}=6.0V$	-	-	0.1	V
			$I_O=4.0mA; V_{CC}=4.5V$	-	-	0.33	V
			$I_O=5.2mA; V_{CC}=6.0V$	-	-	0.33	V
input leakage current	I_I	$V_I=V_{CC} \text{ or } GND; V_{CC}=6.0V$		-	-	± 1.0	μA
supply current	I_{CC}	$V_I=V_{CC} \text{ or } GND; I_O=0A; V_{CC}=6.0V$		-	-	80	μA

AC Characteristics 1

(Tamb=25°C, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Propagation delay	t _{pd}	An to Yn; see Figure 5	V _{CC} =2.0V	-	47	150 ns
			V _{CC} =4.5V	-	17	30 ns
			V _{CC} =5.0V; C _L = 15pF	-	14	- ns
			V _{CC} =6.0V	-	14	26 ns
		E3 to Yn; see Figure 5	V _{CC} =2.0V	-	52	160 ns
			V _{CC} =4.5V	-	19	32 ns
			V _{CC} =5.0V; C _L = 15pF	-	16	- ns
			V _{CC} =6.0V	-	15	27 ns
		$\bar{E}n$ to Yn; see Figure 6	V _{CC} =2.0V	-	50	155 ns
			V _{CC} =4.5V	-	18	31 ns
			V _{CC} =5.0V; C _L = 15pF	-	17	- ns
			V _{CC} =6.0V	-	14	26 ns
transition time	t _t	see Figure 5, 6	V _{CC} =2.0V	-	19	75 ns
			V _{CC} =4.5V	-	7	15 ns
			V _{CC} =6.0V	-	6	13 ns
Power dissipation capacitance	C _{PD}	per package; V _I =GND to V _{CC}	-	72	-	pF

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_t is the same as t_{THL} and t_{TLH}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in uW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

f_i=input frequency in MHz;

f_o=output frequency in MHz;

C_L=output load capacitance in pF;

V_{CC}=supply voltage in V;

N=number of inputs switching;

$\sum (C_L \times V_{CC}^2 \times f_o)$ =sum of outputs.

AC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
propagation delay	t_{pd}	An to Yn; see Figure 5	$V_{CC}=2.0V$	-	-	190	ns
			$V_{CC}=4.5V$	-	-	38	ns
			$V_{CC}=6.0V$	-	-	33	ns
		E3 to Yn; see Figure 5	$V_{CC}=2.0V$	-	-	200	ns
			$V_{CC}=4.5V$	-	-	40	ns
			$V_{CC}=6.0V$	-	-	34	ns
		– En to Yn; see Figure 6	$V_{CC}=2.0V$	-	-	195	ns
			$V_{CC}=4.5V$	-	-	39	ns
			$V_{CC}=6.0V$	-	-	33	ns
transition time	t_t	see Figure 5, 6	$V_{CC}=2.0V$	-	-	95	ns
			$V_{CC}=4.5V$	-	-	19	ns
			$V_{CC}=6.0V$	-	-	16	ns

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_t is the same as t_{THL} and t_{TLH} .

AC Characteristics 3

($T_{amb} = -40^{\circ}\text{C}$ to $+105^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	
propagation delay	t_{pd}	An to Yn; see Figure 5	$V_{CC}=2.0V$	-	-	225	ns
			$V_{CC}=4.5V$	-	-	45	ns
			$V_{CC}=6.0V$	-	-	38	ns
		E3 to Yn; see Figure 5	$V_{CC}=2.0V$	-	-	240	ns
			$V_{CC}=4.5V$	-	-	48	ns
			$V_{CC}=6.0V$	-	-	41	ns
		$\overline{E}n$ to Yn; see Figure 6	$V_{CC}=2.0V$	-	-	235	ns
			$V_{CC}=4.5V$	-	-	47	ns
			$V_{CC}=6.0V$	-	-	40	ns
transition time	t_t	see Figure 5, 6	$V_{CC}=2.0V$	-	-	110	ns
			$V_{CC}=4.5V$	-	-	22	ns
			$V_{CC}=6.0V$	-	-	19	ns

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_t is the same as t_{THL} and t_{TLH} .

Testing Circuit

AC Testing Circuit 1

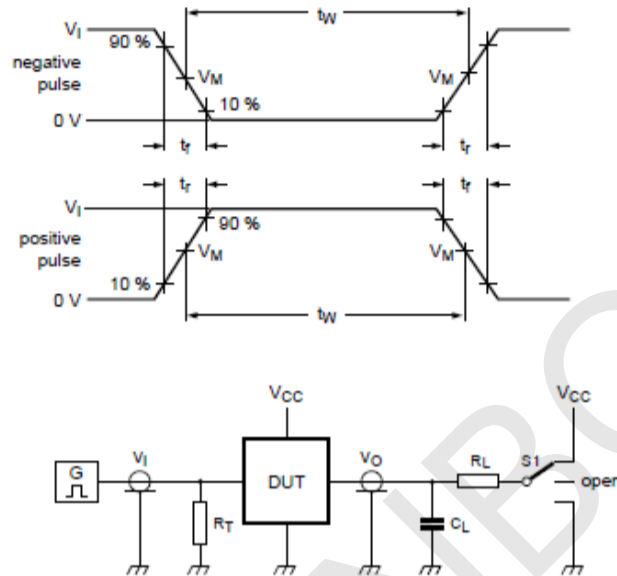


Figure 4. Test circuit for measuring switching times

Definitions for test circuit:

C_L =Load capacitance including jig and probe capacitance.

R_T =Termination resistance should be equal to the output impedance Z_o of the pulse generator.

R_L =Load resistance.

S1=Test selection switch.

AC Testing Waveform

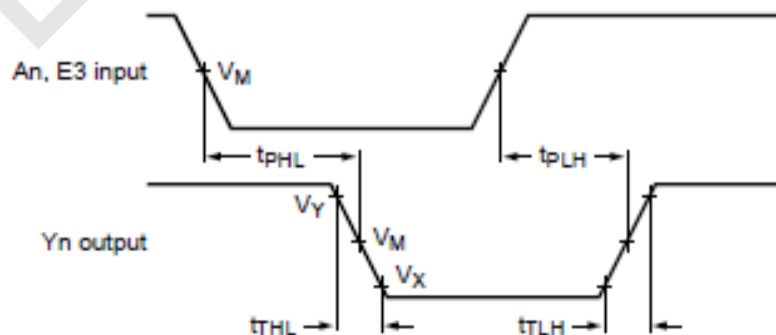


Figure 5. Input (An, E3) to output (Yn) propagation delays and output transition times

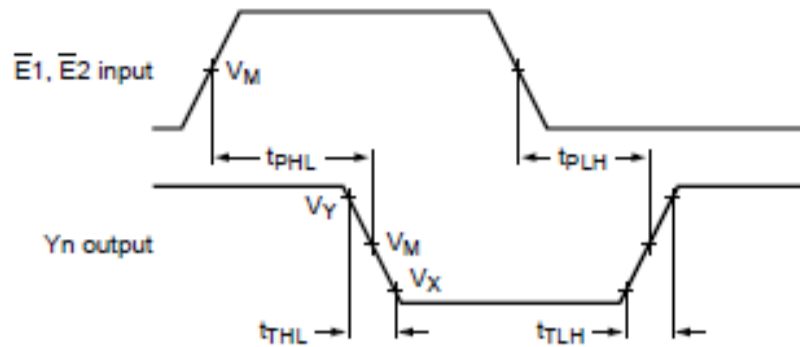


Figure 6. Input ($\bar{E}1$, $\bar{E}2$) to output (Yn) propagation delays and output transition times

Measurement Points

Type	Input	Output		
	V_M	V_M	V_X	V_Y
SN74HC238	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$0.1 \times V_{CC}$	$0.9 \times V_{CC}$

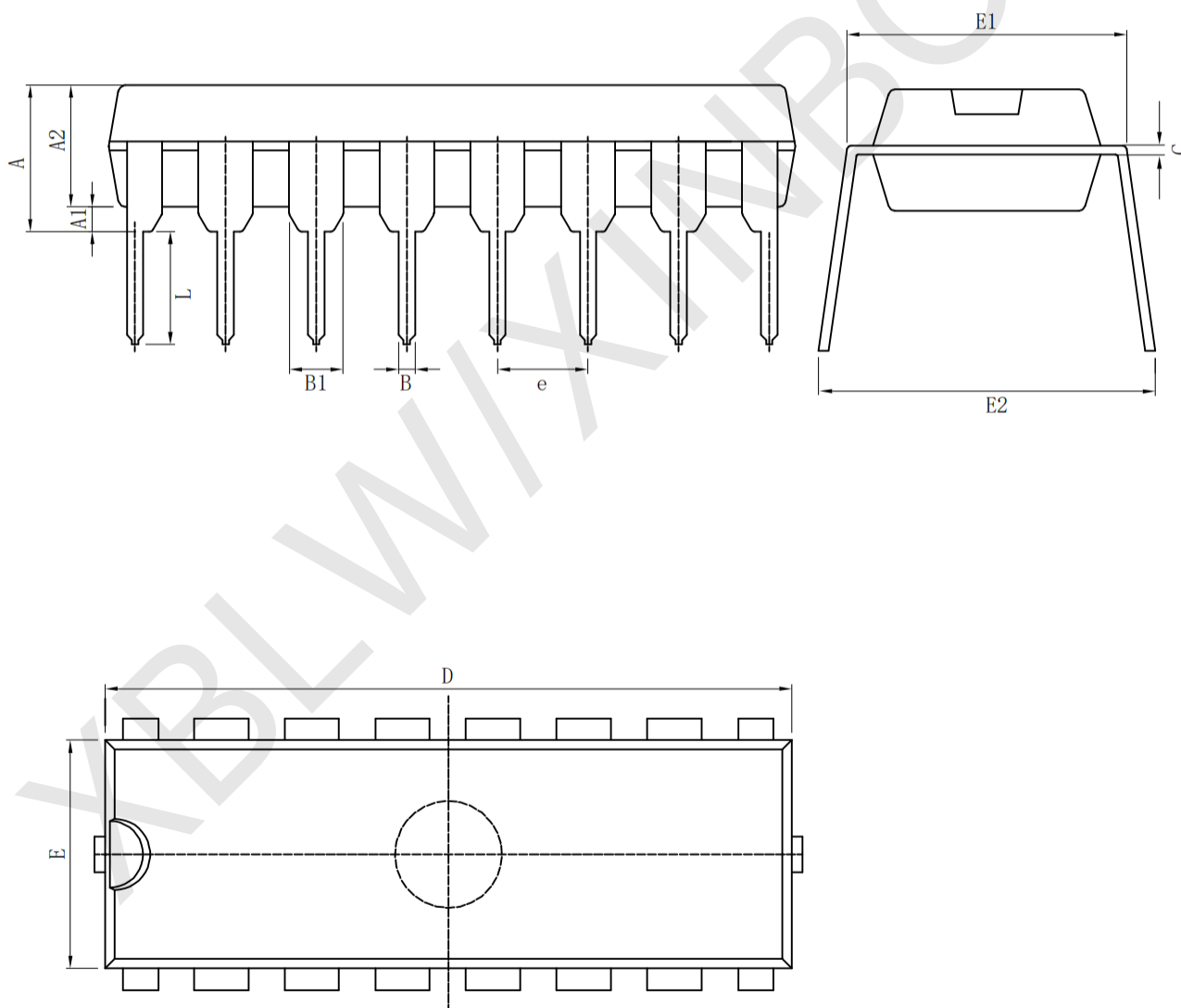
Test Data

Type	Input		Load		S1 position
	V_I	t_r, t_f	C_L	R_L	t_{PHL}, t_{PLH}
SN74HC238	V_{CC}	6ns	15pF, 50pF	1k Ω	open

Package Information

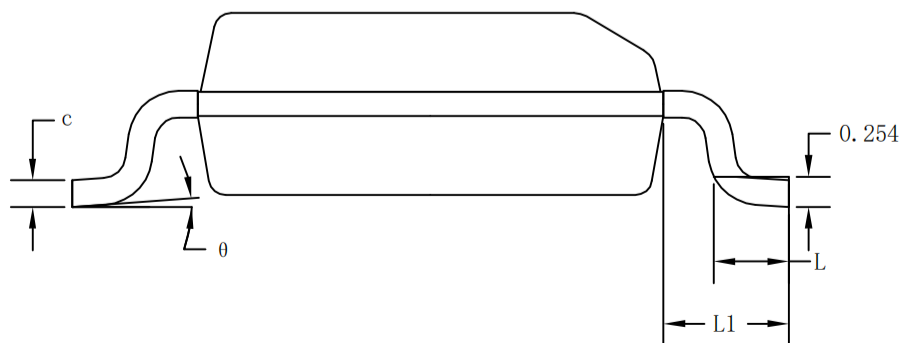
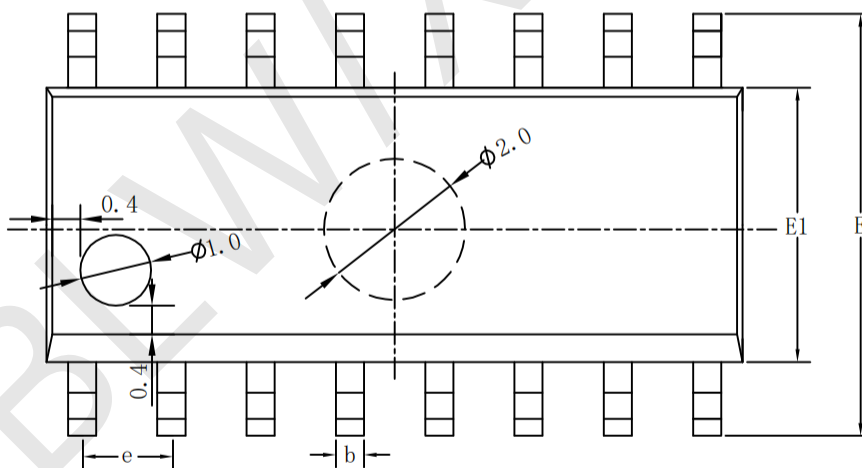
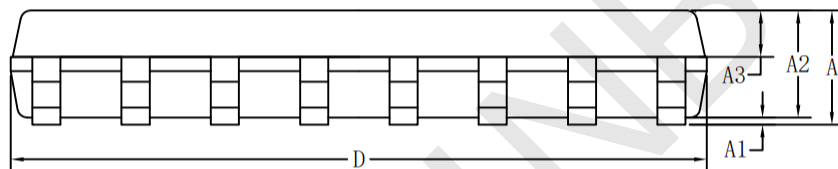
· DIP-16

Symbol	Size	Dimensions In Millimeters		Symbol	Size	Dimensions In Inches	
		Min(mm)	Max(mm)			Min(in)	Max(in)
A		3.710	4.310	A		0.146	0.170
A1		0.510		A1		0.020	
A2		3.200	3.600	A2		0.126	0.142
B		0.380	0.570	B		0.015	0.022
B1		1.524 (BSC)		B1		0.060 (BSC)	
C		0.204	0.360	C		0.008	0.014
D		18.80	19.20	D		0.740	0.756
E		6.200	6.600	E		0.244	0.260
E1		7.320	7.920	E1		0.288	0.312
e		2.540 (BSC)		e		0.100 (BSC)	
L		3.000	3.600	L		0.118	0.142
E2		8.400	9.000	E2		0.331	0.354



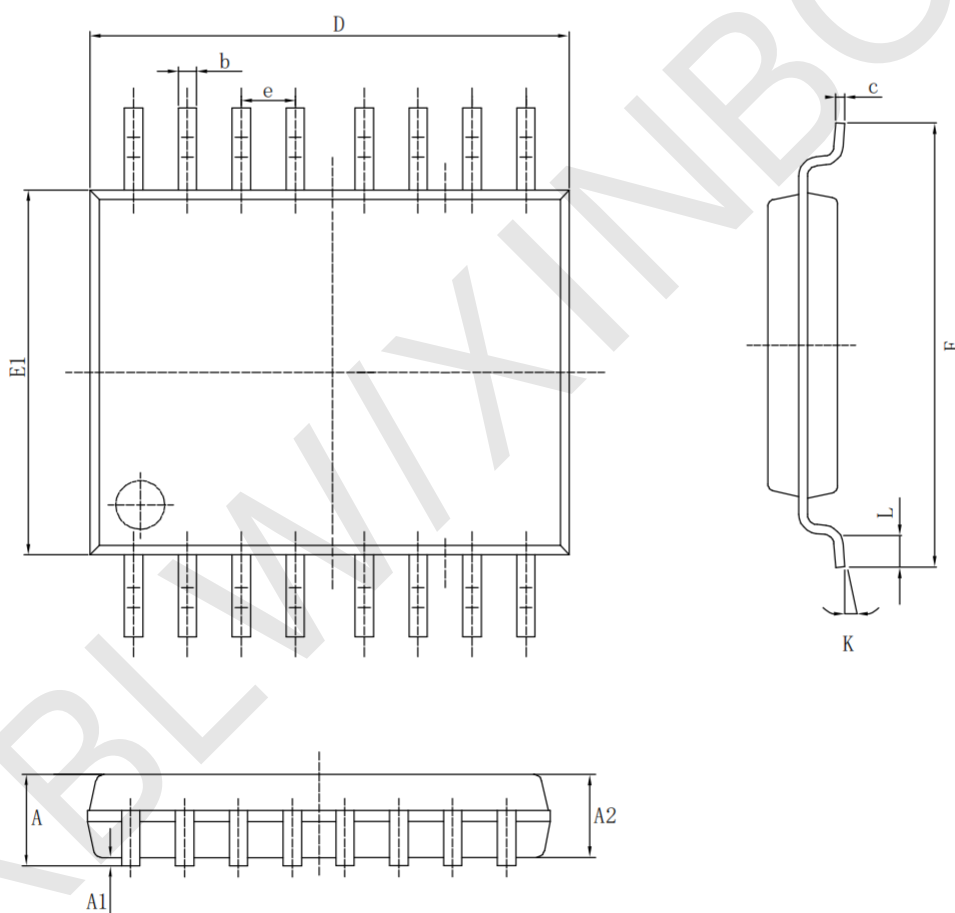
· SOP-16

Symbol	Size	Dimensions In Millimeters			Symbol	Size	Dimensions In Inches		
		Min(mm)	Nom(mm)	Max(mm)			Min(in)	Nom(in)	Max(in)
A		1.500	1.600	1.700	A		0.059	0.063	0.067
A1		0.100	0.150	0.250	A1		0.004	0.006	0.010
A2		1.400	1.450	1.500	A2		0.055	0.057	0.059
A3		0.600	0.650	0.700	A3		0.024	0.026	0.028
b		0.300	0.400	0.500	b		0.012	0.016	0.020
c		0.150	0.200	0.250	c		0.006	0.008	0.010
D		9.800	9.900	10.00	D		0.386	0.390	0.394
E		5.800	6.000	6.200	E		0.228	0.236	0.244
E1		3.850	3.900	3.950	E1		0.152	0.154	0.156
e		1.27 (BSC)			e		0.050 (BSC)		
L		0.500	0.600	0.700	L		0.020	0.024	0.028
L1		1.05 (BSC)			L1		0.041 (BSC)		
θ		0°	4°	8°	θ		0°	4°	8°



· TSSOP-16

Size Symbol	Dimensions In Millimeters		Size Symbol	Dimensions In Inches	
	Min(mm)	Max(mm)		Min(in)	Max(in)
A		1.200	A		0.047
A1	0.050	0.150	A1	0.002	0.006
A2	0.800	1.050	A2	0.031	0.041
b	0.190	0.300	b	0.007	0.012
c	0.090	0.200	c	0.004	0.0089
D	4.900	5.100	D	0.193	0.201
E	6.200	6.600	E	0.244	0.260
E1	4.300	4.480	E1	0.169	0.176
e	0.65 (BSC)		e	0.0256 (BSC)	
K	0°	8°	K	0°	8°
L	0.450	0.750	L	0.018	0.030



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